

To the Director of the U.S.

ed original documents or copy thereof.

102728869

1. Name of conveying party(ies):

1. Yasunao KAI
2. Masahiro YAMAUCHI
3. Kenji OKAMURA

Additional name(s) of conveying party(ies) attached? Yes ☐ No ☒

3. Nature of conveyance:

- ☒ Assignment ☐ Merger  
☐ Security Agreement ☐ Change of Name  
☐ Other

Execution Date: 1. April 2, 2004 2. April 5, 2004

3. April 2, 2004

2. Name and address of receiving party(ies):

Name: Nippon Tungsten Co., Ltd.

Internal Address:

Street Address: 2-8 Minoshima 1-chome, Hakata-ku,  
Fukuoka-shi, Fukuoka, 812-0017, Japan

Additional name(s) & address(es) attached? ☐ Yes ☒ No

4. Application number(s) or patent number(s):

If this document is being filed together with a new application, the filing date of the application is

A. Patent Application No.(s)

10/490,493

B. Patent No.(s)

I hereby certify that this correspondence is being deposited with the United States Postal Services as First Class Mail in an envelope addressed to: Director of the U.S. Patents & Trademarks Office, Mail Stop Assignment Recordation Services, P.O. Box 1450, Alexandria, VA 22313-1450, on April 19, 2004

Dated: April 19, 2004

Frank J. Jordan  
20,456

Additional numbers attached? ☐ Yes ☒ No

5. Name and address of party to whom correspondence concerning document should be mailed:

Name: Frank J. Jordan, Esq.

Internal Address: Jordan and Hamburg LLP

Chanin Building

Suite 4000

Street Address: 122 East 42nd Street

City: New York State: New York Zip: 10168

6. Total number of applications and patents involved:

1

7. Total fee (37 CFR 3.41):.....\$40.00

☐ Enclosed

☒ Authorized to be charged to deposit account

10-1250

8. Charge any excess or credit any refund to the same deposit account number indicated above.

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9. Statement and signature.

To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

Frank J. Jordan, Esq.

Name of Person Signing

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PATENT  
REEL: 015239 FRAME: 0456

**ASSIGNMENT**

For value received, **I, Yasunao KAI, an individual, with post office address at c/o NIPPON TUNGSTEN CO., LTD., 2-8, Minoshima 1-chome, Hakata-ku, Fukuoka-shi, Fukuoka, 812-0017, Japan; I, Masahiro YAMAUCHI, an individual, with post office address at c/o NIPPON TUNGSTEN CO., LTD., 2-8, Minoshima 1-chome, Hakata-ku, Fukuoka-shi, Fukuoka, 812-0017, Japan; I, Kenji OKAMURA, an individual, with post office address at c/o NIPPON TUNGSTEN CO., LTD., 2-8, Minoshima 1-chome, Hakata-ku, Fukuoka-shi, Fukuoka, 812-0017, Japan,** hereinafter assignors, hereby sell, assign and transfer to **Nippon Tungsten Co., Ltd., a corporation existing under the laws of Japan, located at 2-8 Minoshima 1-chome, Hakata-ku, Fukuoka-shi, Fukuoka, 812-0017, Japan,** hereinafter assignee, and said assignee's successors, assigns, and legal representatives the entire right, title, and interest, for all countries including the United States of America, in and to certain inventions relating to **HIGH-DENSITY COMPOSITE MATERIAL** which corresponds to Patent Cooperation Treaty International Application No. **PCT/JP02/10168** filed **September 30, 2002** of which this application is entry into the U.S.A. National Stage, and which is described in an application for Letters Patent of the United States, executed by said assignors respectively concurrently herewith, and all patents which may be granted therefor, and all divisions, reissues, continuations and extensions thereof, and authorize and request the Commissioner of Patents and Trademarks to issue all patents on said improvements or resulting therefrom to said assignee as assignee of the entire interest, and covenant that said assignors have full right so to do, and agree that said

assignors will communicate to said assignee or said assignee's representatives any facts known to said assignors respecting said improvements and testify in any legal proceedings, sign all lawful papers, execute all divisional, continuing and reissue applications, make all rightful oaths and generally do everything possible to aid said assignee, and said assignee's successors, assigns, and nominees, to obtain and enforce proper protection for said invention in the United States.

Signature 甲斐 安直  
Yasunao KAI

Date April 2, 2004

Signature 山内 正博  
Masahiro YAMAUCHI

Date April, 5, 2004

Signature 岡村 研二  
Kenji OKAMURA

Date April 2, 2004